Data Sheet

The new High Temperature **30A** SemiQ[™] Family of DC/DC converters provides a high efficiency single output in a size that is only 60% of industry-standard quarter bricks. Specifically designed for operation in systems that have limited airflow and increased ambient temperatures, the **SQE48T** converters also preserve the same pinout and functionality of the industry-standard quarter bricks.

The **30A SQE48 Series** converters of the **SemiQ[™] Family** provide thermal performance in high temperature environments that exceeds most competitors' 30A quarter bricks. This is accomplished through the use of patent pending circuits, packaging and processing techniques to achieve ultrahigh efficiency, excellent thermal management and a very low body profile.

Low body profile and the preclusion of heatsinks minimize airflow shadowing, thus enhancing cooling for downstream devices. The use of 100% automation for assembly, coupled with di/dt's advanced electronic circuits and thermal design, results in a product with extremely high reliability.

Operating from a 36-75V input, the **30A SQE48 Series** converters provide any standard output voltage from 3.3V down to 1.2V. Outputs can be trimmed from –20% to +10% of the nominal output voltage (±10% for output voltage 1.2V), thus providing outstanding design flexibility.

With standard pinout and trim equations, the **SQE48 Series** converters are perfect drop-in replacements for existing 30A quarter brick designs. Inclusion of this converter in new designs can result in significant board space and cost savings. The designer can expect reliability improvement over other available converters because of the **SQE48 Series**' optimized thermal efficiency.

Applications

- Telecommunications
- Datacommunications
- Wireless
- Servers



SQE48T Converters

Features

- Delivers up to 30A (99W)
- Industry-standard quarter brick pinout
- Extremely small footprint: 0.896" x 2.30" (2.06 in²), 38% smaller than conventional quarter bricks
- Higher current capability at elevated temperatures than most competitors' 30A quarter bricks
- On-board input differential LC-filter
- Outputs available in 3.3, 2.5, 1.8, 1.5, and 1.2V
- High efficiency no heatsink required
- Start up into pre-biased output
- No minimum load required
- Weight: 0.72 oz [20.6 g]
- Meets Basic Insulation requirements of EN60950
- Withstands 100 V input transient for 100 ms
- Fixed frequency operation
- Fully protected
- Remote output sense
- Positive or negative logic ON/OFF option
- Output voltage trim range: +10%/-20% with Industrystandard trim equations (except 1.2V output)
- High reliability: MTBF = TBD million hours, calculated per Telcordia TR-332, Method I Case 1
- UL 60950 recognized in US and Canada and DEMKO certified per IEC/EN 60950 (pending)
- Meets conducted emissions requirements of FCC Class B and EN 55022 Class B with external filter
- All materials meet UL94, V-0 flammability rating

Data Sheet

Electrical Specifications (common to all versions) Conditions: T_A=25°C, Airflow=300 LFM (1.5 m/s), Vin=48 Vdc, All output voltages, unless otherwise specified.

| PARAMETER | NOTES | MIN | TYP | MAX | UNITS |
|--|--------------------------------------|------|-----|-----|-------|
| ABSOLUTE MAXIMUM RATINGS | | | | | |
| Input Voltage | Continuous | 0 | | 80 | Vdc |
| Operating Ambient Temperature | | -40 | | 85 | °C |
| Storage Temperature | | -55 | | 125 | °C |
| INPUT CHARACTERISTICS | | | | | |
| Operating Input Voltage Range | | 36 | 48 | 75 | Vdc |
| Input Under Voltage Lockout | Non-latching | | | | |
| Turn-on Threshold | | 33 | 34 | 35 | Vdc |
| Turn-off Threshold | | 31 | 32 | 33 | Vdc |
| Input Voltage Transient | 100 ms | | | 100 | Vdc |
| ISOLATION CHARACTERISTICS | | | | | |
| I/O Isolation | | 2000 | | | Vdc |
| Isolation Capacitance | | | 160 | | pF |
| Isolation Resistance | | 10 | | | ΜΩ |
| FEATURE CHARACTERISTICS | | | | | |
| Switching Frequency | | | 415 | | kHz |
| Output Voltage Trim Range ¹ | Industry-std. equations (3.3 - 1.5V) | -20 | | +10 | % |
| | Use trim equation on Page 4 (1.2V) | -10 | | +10 | % |
| Remote Sense Compensation ¹ | Percent of V _{OUT} (NOM) | | | +10 | % |
| Output Over-Voltage Protection | Non-latching | 117 | 122 | 127 | % |
| Over-Temperature Shutdown (PCB) | Non-latching | | 125 | | °C |
| Auto-Restart Period | Applies to all protection features | | 100 | | ms |
| Turn-On Time | See Figs. F, G and H | | 7 | | ms |
| ON/OFF Control (Positive Logic) | | | | | |
| Converter Off | | -20 | | 0.8 | Vdc |
| Converter On | | 2.4 | | 20 | Vdc |
| ON/OFF Control (Negative Logic) | | | | | |
| Converter Off | | 2.4 | | 20 | Vdc |
| Converter On | | -20 | | 0.8 | Vdc |

Additional Notes:

^{1.} Vout can be increased up to 10% via the sense leads or up to 10% via the trim function, however total output voltage trim from all sources should not exceed 10% of V_{OUT}(NOM), in order to insure specified operation of over-voltage protection circuitry.

Operation

Input and Output Impedance

These power converters have been designed to be stable with no external capacitors when used in low inductance input and output circuits.

However, in many applications, the inductance associated with the distribution from the power source to the input of the converter can affect the stability of the converter. The addition of a 33µF electrolytic capacitor with an ESR < 1 Ω across the input helps ensure stability of the converter. In many applications, the user has to use decoupling capacitance at the load. The power converter will exhibit stable operation with external load capacitance up to $30,000\mu\text{F}$ on 3.3-1.2V outputs.

ON/OFF (Pin 2)

The ON/OFF pin is used to turn the power converter on or off remotely via a system signal. There are two remote control options available, positive logic and negative logic and both are referenced to Vin(-). Typical connections are shown in Fig. A.

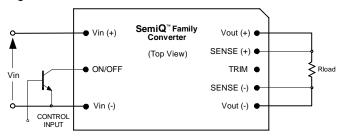


Fig. A: Circuit configuration for ON/OFF function.

The positive logic version turns on when the ON/OFF pin is at a logic high and turns off when at a logic low. The converter is on when the ON/OFF pin is left open.

The negative logic version turns on when the pin is at a logic low and turns off when the pin is at a logic high. The ON/OFF pin can be hard wired directly to Vin(-) to enable automatic power up of the converter without the need of an external control signal.

ON/OFF pin is internally pulled-up to 5V through a resistor. A mechanical switch, open collector transistor, or FET can be used to drive the input of the ON/OFF pin. The device must be capable of sinking up to 0.2mA at a low level voltage of \leq 0.8V. An external voltage source (\pm 20V maximum) may be

Data Sheet

connected directly to the ON/OFF input, in which case it must be capable of sourcing or sinking up to 1mA depending on the signal polarity. See the Start-up Information section for system timing waveforms associated with use of the ON/OFF pin.

Remote Sense (Pins 5 and 7)

The remote sense feature of the converter compensates for voltage drops occurring between the output pins of the converter and the load. The SENSE(-) (Pin 5) and SENSE(+) (Pin 7) pins should be connected at the load or at the point where regulation is required (see Fig. B).

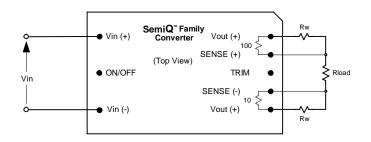


Fig. B: Remote sense circuit configuration.

If remote sensing is not required, the SENSE(-) pin must be connected to the Vout(-) pin (Pin 4), and the SENSE(+) pin must be connected to the Vout(+) pin (Pin 8) to ensure the converter will regulate at the specified output voltage. If these connections are not made, the converter will deliver an output voltage that is slightly higher than the specified value.

Because the sense leads carry minimal current, large traces on the end-user board are not required. However, sense traces should be located close to a ground plane to minimize system noise and insure optimum performance. When wiring discretely, twisted pair wires should be used to connect the sense lines to the load to reduce susceptibility to noise.

The converter's output over-voltage protection (OVP) senses the voltage across Vout(+) and Vout(-), and not across the sense lines, so the resistance (and resulting voltage drop) between the output pins of the converter and the load should be minimized to prevent unwanted triggering of the OVP.

When utilizing the remote sense feature, care must be taken not to exceed the maximum allowable output power capability of the converter, equal to the product of the nominal output voltage and the allowable output current for the given conditions.

When using remote sense, the output voltage at the converter can be increased by as much as 10% above the nominal rating in order to maintain the required voltage across the load. Therefore, the designer must, if necessary, decrease the maximum current (originally obtained from the derating curves) by the same percentage to ensure the converter's actual output power remains at or below the maximum allowable output power.

Output Voltage Adjust /TRIM (Pin 6)

The output voltage can be adjusted up 10% or down 20% for Vout \geq 1.5V, and \pm 10% for Vout = 1.2V relative to the rated output voltage by the addition of an externally connected resistor. For output voltage 3.3V, trim up to 10% is guaranteed only at Vin \geq 40V, and it is marginal (8% to 10%) at Vin = 36V.

The TRIM pin should be left open if trimming is not being used. To minimize noise pickup, a 0.1µF capacitor is connected internally between the TRIM and SENSE(-) pins.

To increase the output voltage, refer to Fig. C. A trim resistor, $R_{\text{T-INCR}}$, should be connected between the TRIM (Pin 6) and SENSE(+) (Pin 7), with a value of:

$$R_{\text{T-INCR}} = \frac{5.11(100 + \Delta) \text{Vo-nom} - 626}{1.225\Delta} - 10.22 \text{ [kΩ] } (3.3 - 1.5 \text{V})$$

$$R_{\text{T-INCR}} = \frac{84.6}{\Delta} - 7.2 \text{ [k}\Omega\text{]} \quad (1.2\text{V})$$

where,

 $\textbf{Rt-INCR} = \textbf{Required value of trim-up resistor } k\Omega]$

Vo-Nom = Nominal value of output voltage [V]

$$\Delta = \left| \frac{\text{(Vo-req - Vo-nom)}}{\text{Vo-nom}} \right| \text{ X 100 [\%]}$$

Vo-REQ = Desired (trimmed) output voltage [V].

When trimming up, care must be taken not to exceed the converter's maximum allowable output power. See previous section for a complete discussion of this requirement.

Data Sheet

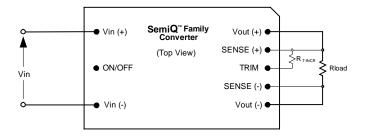


Fig. C: Configuration for increasing output voltage.

To decrease the output voltage (Fig. D), a trim resistor, $R_{T\text{-DECR}}$, should be connected between the TRIM (Pin 6) and SENSE(-) (Pin 5), with a value of:

$$R_{\text{T-DECR}} = \frac{511}{\Delta} - 10.22 \text{ [k}\Omega\text{] } (3.3 - 1.5\text{V})$$

$$R_{\text{T-DECR}} = \frac{700}{\Lambda} - 15 \text{ [k}\Omega\text{] (1.2V)}$$

where

RT-DECR = Required value of trim-down resistor $[k\Omega]$ and Δ is defined above.

Note: The above equations for calculation of trim resistor values match those typically used in conventional industry-standard quarter bricks.

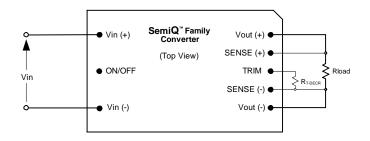


Fig. D: Configuration for decreasing output voltage.

Trimming/sensing beyond 110% of the rated output voltage is not an acceptable design practice, as this condition could cause unwanted triggering of the output over-voltage protection (OVP) circuit. The designer should ensure that the difference between the voltages across the converter's output pins and its sense pins does not exceed 10% of $V_{OUT}(NOM)$, or:

$$[Vout(+) - Vout(-)] - [Vsense(+) - Vsense(-)] \le Vo - nom x 10% [V]$$

This equation is applicable for any condition of output sensing and/or output trim.

Protection Features

Input Under-Voltage Lockout

Input under-voltage lockout is standard with this converter. The converter will shut down when the input voltage drops below a pre-determined voltage.

The input voltage must be typically 34 V for the converter to turn on. Once the converter has been turned on, it will shut off when the input voltage drops typically below 32 V. This feature is beneficial in preventing deep discharging of batteries used in telecom applications.

Output Over-Current Protection (OCP)

The converter is protected against over-current or short circuit conditions. Upon sensing an over-current condition, the converter will switch to constant current operation and thereby begin to reduce output voltage. When the output voltage drops below 60% of the nominal value of output voltage, the converter will shut down (Fig. x.15).

Once the converter has shut down, it will attempt to restart nominally every 100 ms with a typical 3-5% duty cycle (Fig. x.16). The attempted restart will continue indefinitely until the overload or short circuit conditions are removed or the output voltage rises above 40-50% of its nominal value.

Output Over-Voltage Protection (OVP)

The converter will shut down if the output voltage across Vout(+) (Pin 8) and Vout(-) (Pin 4) exceeds the threshold of the OVP circuitry. The OVP circuitry contains its own reference, independent of the output voltage regulation loop. Once the converter has shut down, it will attempt to restart every 100 ms until the OVP condition is removed.

Over-Temperature Protection (OTP)

The converter will shut down under an over-temperature condition to protect itself from overheating caused by operation outside the thermal derating curves, or operation in abnormal conditions such as system fan failure. After the converter has cooled to a safe operating temperature, it will automatically restart.

Safety Requirements

The converters meet North American and International safety regulatory requirements per UL60950 and EN60950 (pending). Basic Insulation is provided between input and output.

Data Sheet

To comply with safety agencies requirements, an input line fuse must be used external to the converter. The Table below provides the recommended fuse rating for use with this family of products.

| Output Voltage | Fuse Rating |
|----------------|-------------|
| 3.3V | 5A |
| 2.5V | 4A |
| 1.8V, 1.5V | 3A |
| 1.2V | 2.5A |

All SQE modules are UL approved for maximum fuse rating of 15A. To protect a group of modules with a single fuse, the rating can be increased from the recommended values above.

Electromagnetic Compatibility (EMC)

EMC requirements must be met at the end-product system level, as no specific standards dedicated to EMC characteristics of board mounted component dc-dc converters exist. However, di/dt tests its converters to several system level standards, primary of which is the more stringent EN55022, Information technology equipment - Radio disturbance characteristics - Limits and methods of measurement.

Effective internal LC differential filter significantly reduces input reflected ripple current (Fig. x.13), and improves EMC.

With the addition of a simple external filter, all versions of the **SQE48 Series** of converters pass the requirements of Class B conducted emissions per EN55022 and FCC, and meet at a minimum, Class A radiated emissions per EN 55022 and Class B per FCC Title 47CFR, Part 15-J. Please contact di/dt Applications Engineering for details of this testing.

Characterization

General Information

The converter has been characterized for many operational aspects, to include thermal derating (maximum load current as a function of ambient temperature and airflow) for vertical and horizontal mounting, efficiency, start-up and shutdown parameters, output ripple and noise, transient response to load step-change, overload and short circuit.

The figures are numbered as Fig. x.y, where x indicates the different output voltages, and y associates with specific plots (y = 1 for the vertical thermal derating, ...). For example, Fig. x.1 will refer to the vertical thermal derating for all the output voltages in general.

The following pages contain specific plots or waveforms associated with the converter. Additional comments for specific data are provided below.

Test Conditions

All data presented were taken with the converter soldered to a test board, specifically a 0.060" thick printed wiring board (PWB) with four layers. The top and bottom layers were not metalized. The two inner layers, comprising two-ounce copper, were used to provide traces for connectivity to the converter.

The lack of metalization on the outer layers as well as the limited thermal connection ensured that heat transfer from the converter to the PWB was minimized. This provides a worst-case but consistent scenario for thermal derating purposes.

All measurements requiring airflow were made in di/dt's vertical and horizontal wind tunnel facilities using Infrared (IR) thermography and thermocouples for thermometry.

Ensuring components on the converter do not exceed their ratings is important to maintaining high reliability. If one anticipates operating the converter at or close to the maximum loads specified in the derating curves, it is prudent to check actual operating temperatures in the application. Thermographic imaging is preferable; if this capability is not available, then thermocouples may be used. di/dt recommends the use of AWG #40 gauge thermocouples to ensure measurement accuracy. Careful routing of the thermocouple leads will further minimize measurement error. Refer to Fig. E for optimum measuring thermocouple locations.

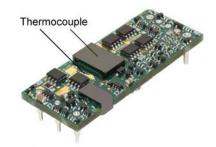


Fig. E: Locations of the thermocouples for thermal testing.

Thermal Derating

Load current vs. ambient temperature and airflow rates are given in Fig. x.1 and Fig. x.2. Ambient temperature was varied between 25°C and 85°C, with airflow rates from 30 to 500 LFM (0.15 to 2.5m/s), for vertical and horizontal converter mounting.

Data Sheet

For each set of conditions, the maximum load current was defined as the lowest of:

- (i) The output current at which any FET junction temperature does not exceed a maximum specified temperature (120°C) as indicated by the thermographic image, or
- (ii) The temperature of the transformer does not exceed 120°C, or
- (iii) The nominal rating of the converter (30A on 3.3 1.2V).

During normal operation, derating curves with maximum FET temperature less or equal to 120°C should not be exceeded. Temperature at both thermocouple locations shown in Fig. E should not exceed 120°C in order to operate inside the derating curves.

Efficiency

Efficiency vs. load current plot is shown in Fig. x.3 for ambient temperature of 25°C, airflow rate of 300 LFM (1.5m/s), vertical converter mounting, and input voltages of 36V, 48V and 72V. Also, a plot of efficiency vs. load current, as a function of ambient temperature with Vin = 48V, airflow rate of 200 LFM (1m/s) with vertical mounting is shown in Fig. x.4.

Power Dissipation

Fig. x.5 shows the power dissipation vs. load current plot for $Ta = 25^{\circ}C$, airflow rate of 300 LFM (1.5m/s) with vertical mounting and input voltages of 36V, 48V and 72V. Also, a plot of power dissipation vs. load current, as a function of ambient temperature with Vin = 48V, airflow rate of 200 LFM (1m/s) with vertical mounting is shown in Fig. x.6.

Start-up

Output voltage waveforms, during the turn-on transient using the ON/OFF pin for full rated load currents (resistive load) are shown without and with external load capacitance in Fig. x.7 and Fig. x.8, respectively.

Ripple and Noise

Fig. x.11 shows the output voltage ripple waveform, measured at full rated load current with a 10 μ F tantalum and 1 μ F ceramic capacitor across the output. Note that all output voltage waveforms are measured across a 1 μ F ceramic capacitor.

The input reflected ripple current waveforms are obtained using the test setup shown in Fig x.12. The corresponding waveforms are shown in Fig. x.13 and Fig. x.14.

Start-up Information (using negative ON/OFF)

Scenario #1: Initial Start-up From Bulk Supply

ON/OFF function enabled, converter started via application of $V_{\text{IN}}.$ See Figure F.

| Time | Comments |
|-----------|--|
| t_0 | ON/OFF pin is ON; system front end power is toggled |
| | on, V _{IN} to converter begins to rise. |
| t_1 | V _{IN} crosses Under-Voltage Lockout protection circuit |
| | threshold; converter enabled. |
| t_2 | Converter begins to respond to turn-on command (con- |
| | verter turn-on delay). |
| t_3 | Converter V _{OUT} reaches 100% of nominal value. |
| or this e | example, the total converter start-up time (t ₃ - t ₁) is typically |

Scenario #2: Initial Start-up Using ON/OFF Pin

7 ms.

With V_{IN} previously powered, converter started via ON/OFF pin. See Figure G.

| See Figur | e G. |
|----------------|---|
| Time | Comments |
| t_0 | V _{INPUT} at nominal value. |
| t ₁ | Arbitrary time when ON/OFF pin is enabled (converter enabled). |
| t_2 | End of converter turn-on delay. |
| t_3 | Converter V _{OUT} reaches 100% of nominal value. |
| For this ex | cample, the total converter start-up time (t ₃ - t ₁) is typically |
| 7 ms. | |

Scenario #3: Turn-off and Restart Using ON/OFF Pin

With V_{IN} previously powered, converter is disabled and then enabled via ON/OFF pin. See Figure H.

| abled via | ON/OFF pin. See Figure H. |
|------------|--|
| Time | Comments |
| t_0 | V _{IN} and V _{OUT} are at nominal values; ON/OFF pin ON. |
| t_1 | ON/OFF pin arbitrarily disabled; converter output falls |
| | to zero; turn-on inhibit delay period (100 ms typical) is |
| | initiated, and ON/OFF pin action is internally inhibited. |
| t_2 | ON/OFF pin is externally re-enabled. |
| | If $(t_2-t_1) \le 100$ ms, external action of ON/OFF pin |
| | is locked out by start-up inhibit timer. |
| | If $(t_2-t_1) > 100 \text{ ms}$, ON/OFF pin action is internally |
| | enabled. |
| t_3 | Turn-on inhibit delay period ends. If ON/OFF pin is ON, |
| | converter begins turn-on; if off, converter awaits |
| | ON/OFF pin ON signal; see Figure G. |
| t_4 | End of converter turn-on delay. |
| t_5 | Converter V _{OUT} reaches 100% of nominal value. |
| For the co | ondition, $(t_2-t_1) \le 100 \text{ ms}$, the total converter start-up |
| | e) is typically 107 ms. For $(t_2-t_1) > 100$ ms, start-up will |
| be typical | ly 7 ms after release of ON/OFF pin. |

Data Sheet

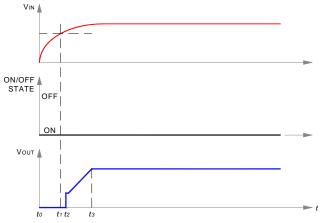


Fig. F: Start-up scenario #1.

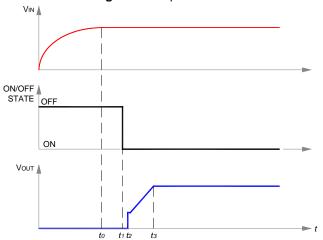


Fig. G: Start-up scenario #2.

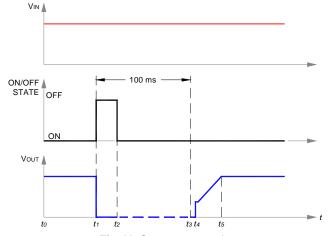


Fig. H: Start-up scenario #3.

Data Sheet

Electrical Specifications: SQE48T30033 (3.3 Volt Out)

Conditions: T_A=25°C, Airflow=300 LFM (1.5 m/s), Vin=48 Vdc, Vout=3.3 Vdc unless otherwise specified.

| PARAMETER | NOTES | MIN | TYP | MAX | UNITS |
|---|---|-------|-------|--------|---------------------|
| INPUT CHARACTERISTICS | | | | | |
| Maximum Input Current | 30 Adc, 3.3 Vdc Out @ 36 Vdc In | | | 3.1 | Adc |
| Input Stand-by Current | Vin = 48 V, converter disabled | | 3 | | mAdc |
| Input No Load Current (0 load on the output) | Vin = 48 V, converter enabled | | 37 | | mAdc |
| Input Reflected-Ripple Current | 25MHz bandwidth | | 8 | | mA _{PK-PK} |
| Input Voltage Ripple Rejection | 120Hz | | 91 | | dB |
| OUTPUT CHARACTERISTICS | | | | | |
| Output Voltage Set Point (no load) | | 3.267 | 3.300 | 3.333 | Vdc |
| Output Regulation | | | | | |
| Over Line | | | ±2 | ±5 | mV |
| Over Load | | | ±2 | ±5 | mV |
| Output Voltage Range | Over line, load and temperature ² | 3.250 | | 3.350 | Vdc |
| Output Ripple and Noise - 25MHz bandwidth | Full load + 10 µF tantalum + 1 µF ceramic | | 30 | 50 | mV_{PK-PK} |
| External Load Capacitance | Plus full load (resistive) | | | 30,000 | μF |
| Output Current Range | | 0 | | 30 | Adc |
| Current Limit Inception | Non-latching | 33 | 36.5 | 40 | Adc |
| Peak Short-Circuit Current | Non-latching. Short=10mΩ. | | 35 | 46 | Α |
| RMS Short-Circuit Current | Non-latching | | | 8 | Arms |
| DYNAMIC RESPONSE | | | | | |
| Load Change 10A - 20A - 10A, di/dt = 0.1 A/µS | Co = 1 µF ceramic (Fig. 3.3V.9) | | 75 | | mV |
| $di/dt = 5 A/\mu S$ | Co = 470 μF POS + 1 μF ceramic (Fig. 3.3V.10) | | 160 | | mV |
| Setting Time to 1% | | | 50 | | μs |
| EFFICIENCY | | | | | |
| 100% Load | | | 91 | | % |
| 50% Load | | | 92.5 | | % |

Additional Notes: 2. -40°C to 85°C

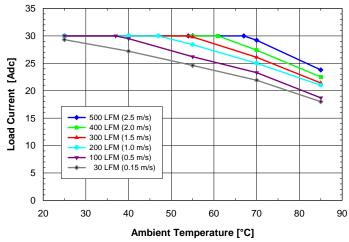


Fig. 3.3V.1: Available load current vs. ambient air temperature and airflow rates for **SQE48T30033** converter with D height pins mounted vertically with air flowing from pin 3 to pin 1, MOSFET temperature \leq 120°C, Vin = 48V.

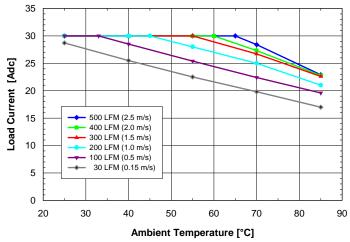


Fig. 3.3V.2: Available load current vs. ambient air temperature and airflow rates for **SQE48T30033** converter with D height pins mounted horizontally with air flowing from pin 3 to pin 1, MOSFET temperature \leq 120°C, Vin = 48V.

Data Sheet

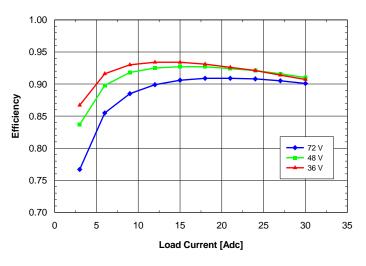


Fig. 3.3V.3: Efficiency vs. load current and input voltage for **SQE48T30033** converter mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5m/s) and $Ta = 25^{\circ}C$.

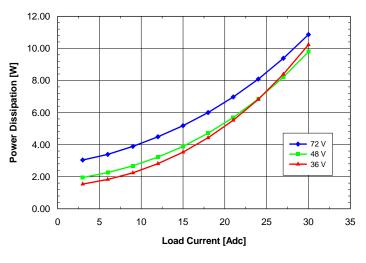


Fig. 3.3V.5: Power dissipation vs. load current and input voltage for **SQE48T30033** converter mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5m/s) and Ta = 25° C.

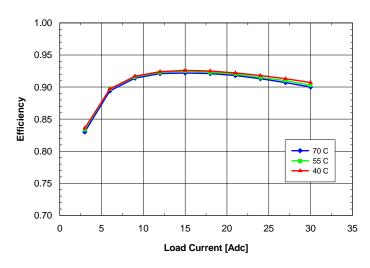


Fig. 3.3V.4: Efficiency vs. load current and ambient temperature for **SQE48T30033** converter mounted vertically with Vin = 48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).

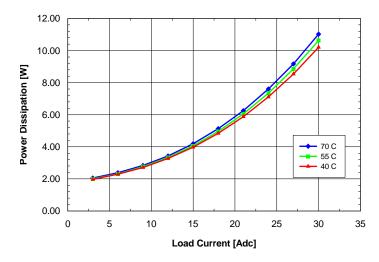


Fig. 3.3V.6: Power dissipation vs. load current and ambient temperature for **SQE48T30033** converter mounted vertically with Vin = 48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).

Data Sheet

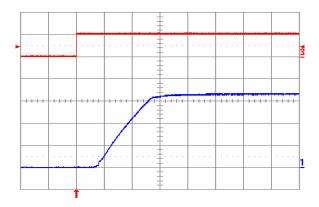


Fig. 3.3V.7: Turn-on transient at full rated load current (resistive) with no output capacitor at Vin = 48V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5V/div.). Bottom trace: output voltage (1V/div.). Time scale: 2ms/div.

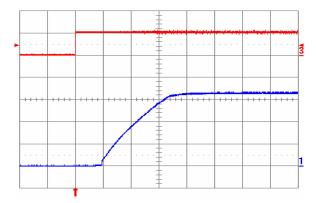


Fig. 3.3V.8: Turn-on transient at full rated load current (resistive) plus 10,000 μ F at Vin = 48V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5V/div.). Bottom trace: output voltage (1V/div.). Time scale: 2ms/div.

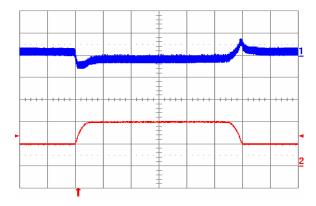


Fig. 3.3V.9: Output voltage response to load current stepchange (10A - 20A - 10A) at Vin = 48V. Top trace: output voltage (100mV/div.). Bottom trace: load current (10A/div.). Current slew rate: $0.1A/\mu s$. Co = $1\mu F$ ceramic. Time scale: 0.2ms/div.

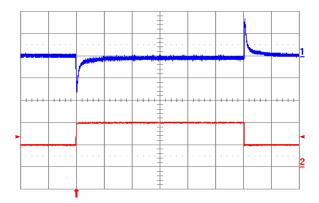


Fig. 3.3V.10: Output voltage response to load current stepchange (10A - 20A - 10A) at Vin = 48V. Top trace: output voltage (100mV/div.). Bottom trace: load current (10A/div.). Current slew rate: $5A/\mu s$. Co = $470\mu F$ POS + $1\mu F$ ceramic. Time scale: 0.2ms/div.

Data Sheet

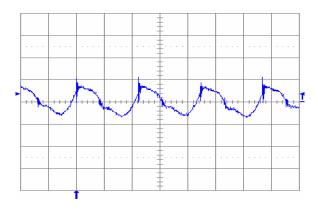


Fig. 3.3V.11: Output voltage ripple (20mV/div.) at full rated load current into a resistive load with Co = $10\mu\text{F}$ tantalum + $1\mu\text{F}$ ceramic and Vin = 48V. Time scale: $1\mu\text{S/div.}$

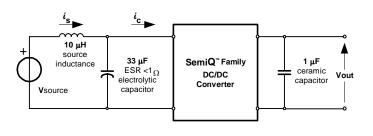


Fig. 3.3V.12: Test Set-up for measuring input reflected ripple currents, i_c and i_s .

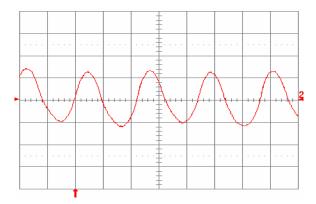


Fig. 3.3V.13: Input reflected ripple current, i_c (50mA/div.), measured at input terminals at full rated load current and Vin = 48V. Refer to Fig. 3.3V.12 for test setup. Time scale: $1\mu s/div$.

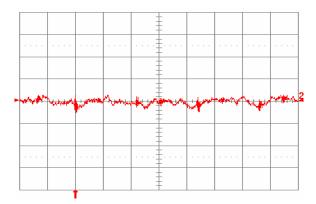


Fig. 3.3V.14: Input reflected ripple current, i_s (10mA/div.), measured through 10 μ H at the source at full rated load current and Vin = 48V. Refer to Fig. 3.3V.12 for test setup. Time scale: 1 μ s/div.

Data Sheet

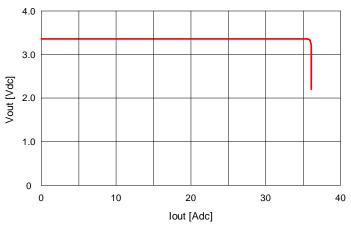


Fig. 3.3V.15: Output voltage vs. load current showing current limit point and converter shutdown point. Input voltage has almost no effect on current limit characteristic.

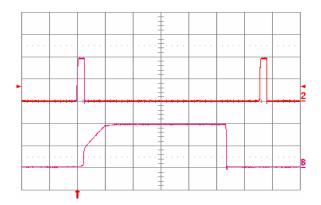


Fig. 3.3V.16: Load current (top trace, 20A/div., 20ms/div.) into a 10m Ω short circuit during restart, at Vin = 48V. Bottom trace (20A/div., 1ms/div.) is an expansion of the on-time portion of the top trace.

Data Sheet

Electrical Specifications: SQE48T30025 (2.5 Volt Out)

Conditions: T_A=25°C, Airflow=300 LFM (1.5 m/s), Vin=48 Vdc, Vout=2.5 Vdc unless otherwise specified.

| PARAMETER | NOTES | MIN | TYP | MAX | UNITS |
|---|---|-------|-------|--------|---------------------|
| INPUT CHARACTERISTICS | | | | | |
| Maximum Input Current | 30 Adc, 2.5 Vdc Out @ 36 Vdc In | | | 2.4 | Adc |
| Input Stand-by Current | Vin = 48V, converter disabled | | 3 | | mAdc |
| Input No Load Current (0 load on the output) | Vin = 48V, converter enabled | | 32 | | mAdc |
| Input Reflected-Ripple Current | 25MHz bandwidth | | 6 | | mA _{PK-PK} |
| Input Voltage Ripple Rejection | 120Hz | | 60 | | dB |
| OUTPUT CHARACTERISTICS | | | | | |
| Output Voltage Set Point (no load) | -40°C to 85°C | 2.475 | 2.500 | 2.525 | Vdc |
| Output Regulation | | | | | |
| Over Line | | | ±2 | ±5 | mV |
| Over Load | | | ±2 | ±5 | mV |
| Output Voltage Range | Over line, load and temperature | 2.462 | | 2.538 | Vdc |
| Output Ripple and Noise - 25MHz bandwidth | Full load + 10 μF tantalum + 1 μF ceramic | | 30 | 50 | mV_{PK-PK} |
| External Load Capacitance | Plus full load (resistive) | | | 30,000 | μF |
| Output Current Range | | 0 | | 30 | Adc |
| Current Limit Inception | Non-latching | 33 | 36.5 | 40 | Adc |
| Peak Short-Circuit Current | Non-latching. Short=10mΩ. | | 35 | 46 | Α |
| RMS Short-Circuit Current | Non-latching | | | 8 | Arms |
| DYNAMIC RESPONSE | | | | | |
| Load Change 10A - 20A - 10A, di/dt = 0.1 A/µS | Co = 1 μ F ceramic (Fig. 2.5V.9) | | 70 | | mV |
| $di/dt = 5 A/\mu S$ | Co = 470 μ F POS + 1 μ F ceramic (Fig. 2.5V.10) | | 160 | | mV |
| Setting Time to 1% | | | 50 | | μs |
| EFFICIENCY | | | | | |
| 100% Load | | | 89.5 | | % |
| 50% Load | | | 91.5 | | % |

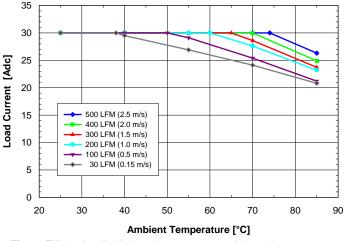


Fig. 2.5V.1: Available load current vs. ambient air temperature and airflow rates for SQE48T30025 converter with D height pins mounted vertically with air flowing from pin 3 to pin 1, MOSFET temperature \leq 120°C, Vin = 48V.

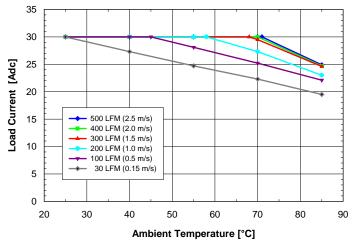


Fig. 2.5V.2: Available load current vs. ambient air temperature and airflow rates for **SQE48T30025** converter with D height pins mounted horizontally with air flowing from pin 3 to pin 1, MOSFET temperature $\leq 120^{\circ}$ C, Vin = 48V.

Data Sheet

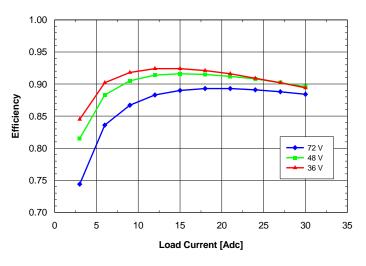


Fig. 2.5V.3: Efficiency vs. load current and input voltage for **SQE48T30025** converter mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5m/s) and $Ta = 25^{\circ}C$.

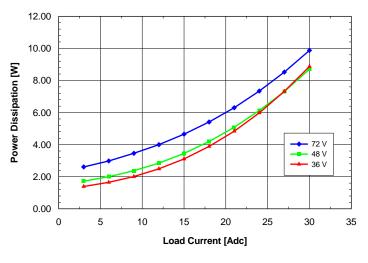


Fig. 2.5V.5: Power dissipation vs. load current and input voltage for **SQE48T30025** converter mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5m/s) and Ta = 25° C.

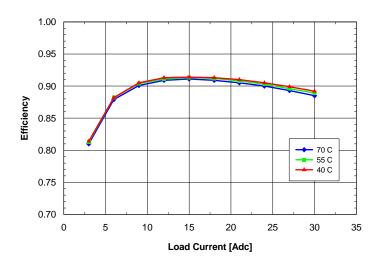


Fig. 2.5V.4: Efficiency vs. load current and ambient temperature for **SQE48T30025** converter mounted vertically with Vin = 48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).

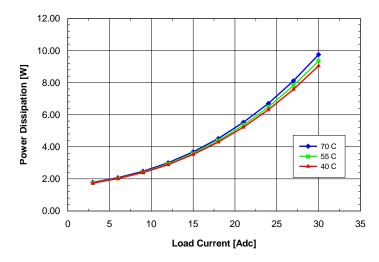


Fig. 2.5V.6: Power dissipation vs. load current and ambient temperature for **SQE48T30025** converter mounted vertically with Vin = 48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).

Data Sheet

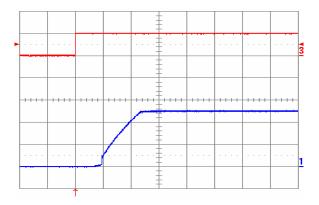


Fig. 2.5V.7: Turn-on transient at full rated load current (resistive) with no output capacitor at Vin = 48V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5V/div.). Bottom trace: output voltage (1V/div.). Time scale: 2ms/div.

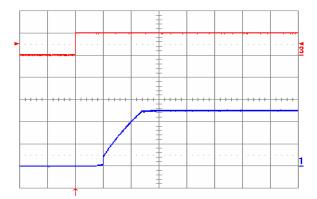


Fig. 2.5V.8: Turn-on transient at full rated load current (resistive) plus 10,000 μ F at Vin = 48V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5V/div.). Bottom trace: output voltage (1V/div.). Time scale: 2ms/div.

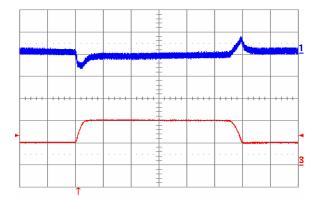


Fig. 2.5V.9: Output voltage response to load current stepchange (10A - 20A - 10A) at Vin = 48V. Top trace: output voltage (100mV/div.). Bottom trace: load current (10A/div.). Current slew rate: $0.1A/\mu s$. Co = $1\mu F$ ceramic. Time scale: 0.2ms/div.

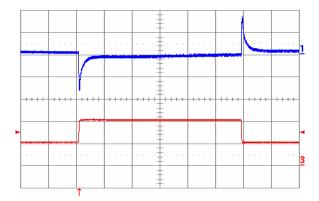


Fig. 2.5V.10: Output voltage response to load current stepchange (10A - 20A - 10A) at Vin = 48V. Top trace: output voltage (100mV/div.). Bottom trace: load current (10A/div.). Current slew rate: $5A/\mu s$. Co = $470\mu F$ POS + $1\mu F$ ceramic. Time scale: 0.2ms/div.

Data Sheet

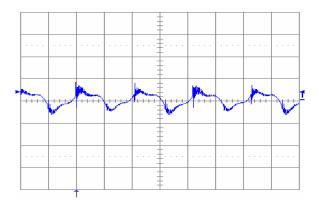


Fig. 2.5V.11: Output voltage ripple (20mV/div.) at full rated load current into a resistive load with Co = $10\mu\text{F}$ tantalum + $1\mu\text{F}$ ceramic and Vin = 48V. Time scale: $1\mu\text{S/div.}$

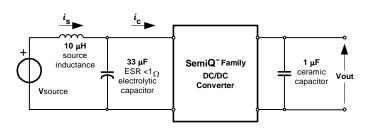


Fig. 2.5V.12: Test Set-up for measuring input reflected ripple currents, i_c and i_s .

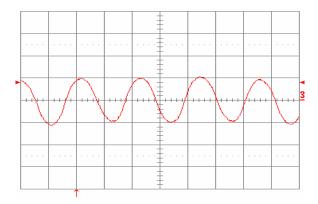


Fig. 2.5V.13: Input reflected ripple current, i_c (50 mA/div.), measured at input terminals at full rated load current and Vin = 48V. Refer to Fig. 2.5V.12 for test setup. Time scale: 1 μ s/div.

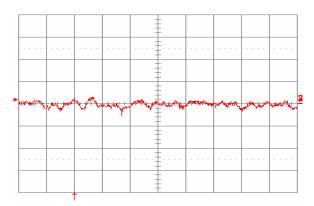


Fig. 2.5V.14: Input reflected ripple current, i_s (10mA/div.), measured through 10 μ H at the source at full rated load current and Vin = 48V. Refer to Fig. 2.5V.12 for test setup. Time scale: 1μ s/div.

Data Sheet

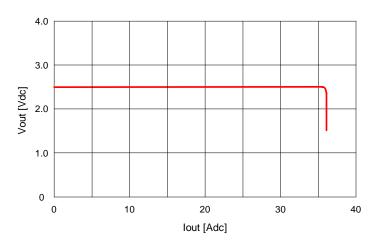


Fig. 2.5V.15: Output voltage vs. load current showing current limit point and converter shutdown point. Input voltage has almost no effect on current limit characteristic.

Fig. 2.5V.16: Load current (top trace, 20A/div., 20ms/div.) into a 10 m Ω short circuit during restart, at Vin = 48V. Bottom trace (20A/div., 1ms/div.) is an expansion of the on-time portion of the top trace.

Data Sheet

Electrical Specifications: SQE48T30018 (1.8 Volt Out)

Conditions: T_A=25°C, Airflow=300 LFM (1.5 m/s), Vin=48 Vdc, Vout=1.8 Vdc unless otherwise specified.

| PARAMETER | NOTES | MIN | TYP | MAX | UNITS |
|---|---|-------|-------|--------|---------------------|
| INPUT CHARACTERISTICS | | | | | |
| Maximum Input Current | 30 Adc, 1.8 Vdc Out @ 36 Vdc In | | | 1.7 | Adc |
| Input Stand-by Current | Vin = 48V, converter disabled | | 3 | | mAdc |
| Input No Load Current (0 load on the output) | Vin = 48V, converter enabled | · | 28 | · | mAdc |
| Input Reflected-Ripple Current | 25MHz bandwidth | | 6 | | mA _{PK-PK} |
| Input Voltage Ripple Rejection | 120Hz | | 70 | | dB |
| OUTPUT CHARACTERISTICS | | | | | |
| Output Voltage Set Point (no load) | -40°C to 85°C | 1.782 | 1.800 | 1.818 | Vdc |
| Output Regulation | | | | | |
| Over Line | | | ±2 | ±4 | mV |
| Over Load | | | ±2 | ±5 | mV |
| Output Voltage Range | Over line, load and temperature | 1.773 | | 1.827 | Vdc |
| Output Ripple and Noise - 25MHz bandwidth | Full load + 10 µF tantalum + 1 µF ceramic | | 25 | 40 | mV_{PK-PK} |
| External Load Capacitance | Plus full load (resistive) | | | 30,000 | μF |
| Output Current Range | | 0 | | 30 | Adc |
| Current Limit Inception | Non-latching | 33 | 36.5 | 40 | Adc |
| Peak Short-Circuit Current | Non-latching. Short=10mΩ. | | 35 | 46 | Α |
| RMS Short-Circuit Current | Non-latching | | | 8 | Arms |
| DYNAMIC RESPONSE | | | | | |
| Load Change 10A - 20A - 10A, di/dt = 0.1 A/µS | Co = 1 µF ceramic (Fig. 1.8V.9) | | 50 | | mV |
| $di/dt = 5 A/\mu S$ | Co = 470 μ F POS + 1 μ F ceramic (Fig. 1.8V.10) | | 150 | | mV |
| Setting Time to 1% | | | 50 | | μs |
| EFFICIENCY | | | | | |
| 100% Load | | | 87 | | % |
| 50% Load | | | 89.5 | | % |

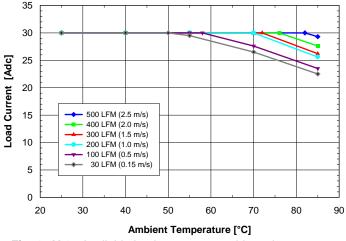


Fig. 1.8V.1: Available load current vs. ambient air temperature and airflow rates for **SQE48T30018** converter with D height pins mounted vertically with air flowing from pin 3 to pin 1, MOSFET temperature $\leq 120^{\circ}$ C, Vin = 48 V.

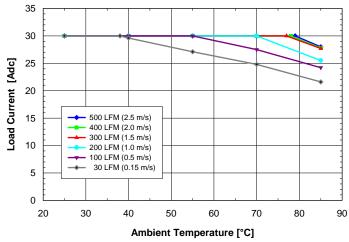


Fig. 1.8V.2: Available load current vs. ambient air temperature and airflow rates for SQE48T30018 converter with D height pins mounted horizontally with air flowing from pin 3 to pin 1, MOSFET temperature \leq 120°C, Vin = 48 V.

Data Sheet

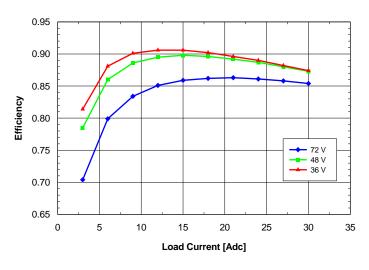


Fig. 1.8V.3: Efficiency vs. load current and input voltage for **SQE48T30018** converter mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5m/s) and $Ta = 25^{\circ}C$.

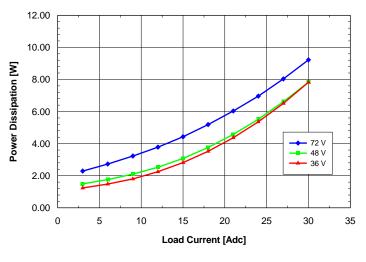


Fig. 1.8V.5: Power dissipation vs. load current and input voltage for **SQE48T30018** converter mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5m/s) and Ta = 25° C.

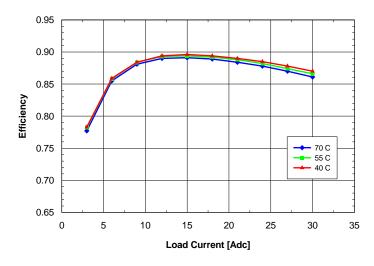


Fig. 1.8V.4: Efficiency vs. load current and ambient temperature for **SQE48T30018** converter mounted vertically with Vin = 48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).

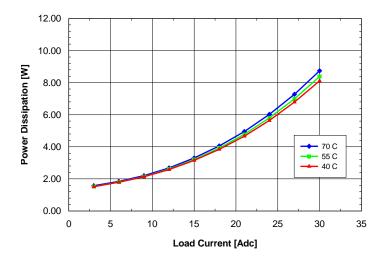


Fig. 1.8V.6: Power dissipation vs. load current and ambient temperature for **SQE48T30018** converter mounted vertically with Vin = 48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).

Data Sheet

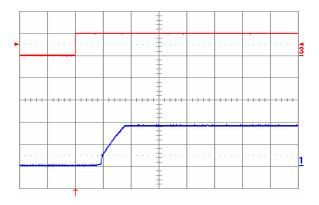


Fig. 1.8V.7: Turn-on transient at full rated load current (resistive) with no output capacitor at Vin = 48V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5V/div.). Bottom trace: output voltage (1V/div.). Time scale: 2ms/div.

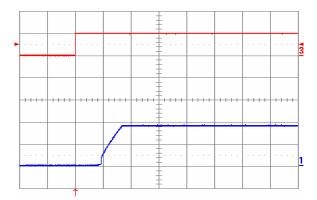


Fig. 1.8V.8: Turn-on transient at full rated load current (resistive) plus 10,000 μ F at Vin = 48V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5V/div.). Bottom trace: output voltage (1V/div.). Time scale: 2ms/div.

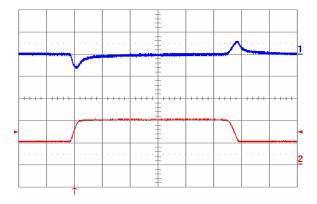


Fig. 1.8V.9: Output voltage response to load current stepchange (10A - 20A - 10A) at Vin = 48V. Top trace: output voltage (100mV/div.). Bottom trace: load current (10A/div.). Current slew rate: $0.1A/\mu s$. Co = $1\mu F$ ceramic. Time scale: 0.2ms/div.

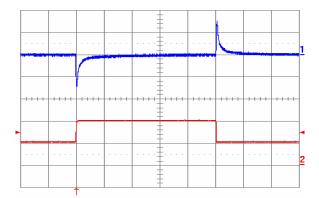


Fig. 1.8V.10: Output voltage response to load current stepchange (10A - 20A - 10A) at Vin = 48V. Top trace: output voltage (100mV/div.). Bottom trace: load current (10A/div.). Current slew rate: $5A/\mu s$. Co = $470\mu F$ POS + $1\mu F$ ceramic. Time scale: 0.2ms/div.

Data Sheet

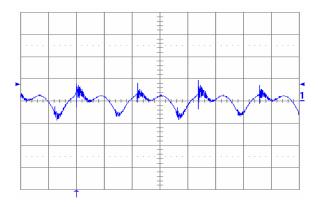


Fig. 1.8V.11: Output voltage ripple (20mV/div.) at full rated load current into a resistive load with Co = $10\mu\text{F}$ tantalum + $1\mu\text{F}$ ceramic and Vin = 48V. Time scale: $1\mu\text{S/div.}$

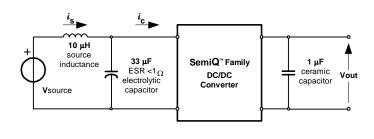


Fig. 1.8V.12: Test Set-up for measuring input reflected ripple currents, i_c and i_s .

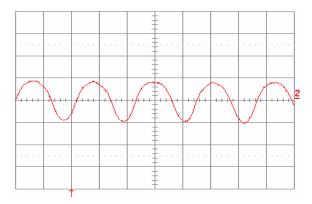


Fig. 1.8V.13: Input reflected ripple current, \emph{i}_{c} (50mA/div.), measured at input terminals at full rated load current and Vin = 48V. Refer to Fig. 1.8V.12 for test setup. Time scale: $1\mu s/div$.

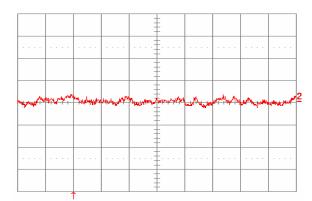


Fig. 1.8V.14: Input reflected ripple current, i_s (10mA/div.), measured through 10 μ H at the source at full rated load current and Vin = 48V. Refer to Fig. 1.8V.12 for test setup. Time scale: 1μ S/div.

Data Sheet

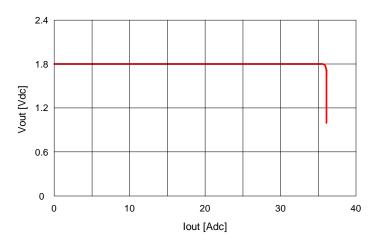


Fig. 1.8V.15: Output voltage vs. load current showing current limit point and converter shutdown point. Input voltage has almost no effect on current limit characteristic.

Fig. 1.8V.16: Load current (top trace, 20A/div., 20ms/div.) into a 10 m Ω short circuit during restart, at Vin = 48V. Bottom trace (20A/div., 1ms/div.) is an expansion of the on-time portion of the top trace.

Data Sheet

Electrical Specifications: SQE48T30015 (1.5 Volt Out)

Conditions: T_A=25°C, Airflow=300 LFM (1.5 m/s), Vin=48 Vdc, Vout=1.5 Vdc unless otherwise specified.

| PARAMETER | NOTES | MIN | TYP | MAX | UNITS |
|---|--|-------|-------|--------|---------------------|
| INPUT CHARACTERISTICS | | | | | |
| Maximum Input Current | 30 Adc, 1.5 Vdc Out @ 36 Vdc In | | | 1.5 | Adc |
| Input Stand-by Current | Vin = 48V, converter disabled | | 3 | | mAdc |
| Input No Load Current (0 load on the output) | Vin = 48V, converter enabled | | 25 | | mAdc |
| Input Reflected-Ripple Current | 25MHz bandwidth | | 6 | | mA _{PK-PK} |
| Input Voltage Ripple Rejection | 120Hz | | 65 | | dB |
| OUTPUT CHARACTERISTICS | | | | | |
| Output Voltage Set Point (no load) | -40°C to 85°C | 1.485 | 1.500 | 1.515 | Vdc |
| Output Regulation | | | | | |
| Over Line | | | ±2 | ±4 | mV |
| Over Load | | | ±2 | ±4 | mV |
| Output Voltage Range | Over line, load and temperature | 1.477 | | 1.523 | Vdc |
| Output Ripple and Noise - 25MHz bandwidth | Full load + 10 μF tantalum + 1 μF ceramic | | 20 | 30 | mV_{PK-PK} |
| External Load Capacitance | Plus full load (resistive) | | | 30,000 | μF |
| Output Current Range | | 0 | | 30 | Adc |
| Current Limit Inception | Non-latching | 33 | 36.5 | 40 | Adc |
| Peak Short-Circuit Current | Non-latching. Short= $10m\Omega$. | | 35 | 46 | Α |
| RMS Short-Circuit Current | Non-latching | | | 8 | Arms |
| DYNAMIC RESPONSE | | | | | |
| Load Change 10A - 20A - 10A, di/dt = 0.1 A/µS | Co = 1 µF ceramic (Fig. 1.5V.9) | | 40 | | mV |
| $di/dt = 5 A/\mu S$ | Co = 470 μ F POS + 1 μ F ceramic(Fig. 1.5V.10) | | 140 | | mV |
| Setting Time to 1% | | | 50 | | μs |
| EFFICIENCY | | | | | |
| 100% Load | | | 86 | | % |
| 50% Load | | | 88.5 | | % |

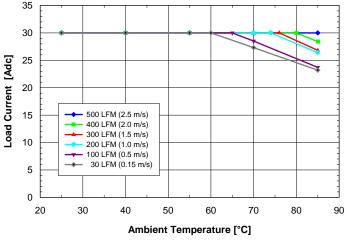


Fig. 1.5V.1: Available load current vs. ambient air temperature and airflow rates for **SQE48T30015** converter with D height pins mounted vertically with air flowing from pin 3 to pin 1, MOSFET temperature $\leq 120^{\circ}$ C, Vin = 48V.

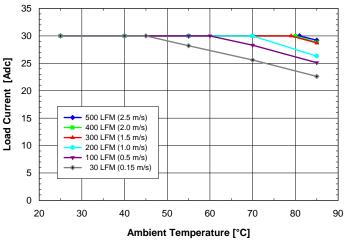


Fig. 1.5V.2: Available load current vs. ambient air temperature and airflow rates for **SQE48T30015** converter with D height pins mounted horizontally with air flowing from pin 3 to pin 1, MOSFET temperature $\leq 120^{\circ}$ C, Vin = 48V.

Data Sheet

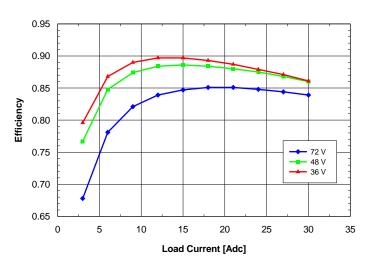


Fig. 1.5V.3: Efficiency vs. load current and input voltage for SQE48T30015 converter mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5m/s) and $Ta = 25^{\circ}C$.

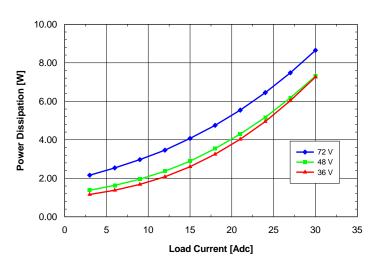


Fig. 1.5V.5: Power dissipation vs. load current and input voltage for **SQE48T30015** converter mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5m/s) and Ta = 25° C.

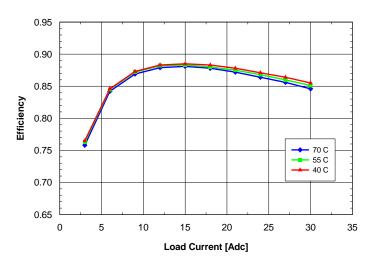


Fig. 1.5V.4: Efficiency vs. load current and ambient temperature for **SQE48T30015** converter mounted vertically with Vin = 48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).

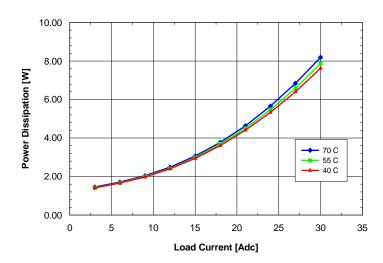


Fig. 1.5V.6: Power dissipation vs. load current and ambient temperature for **SQE48T30015** converter mounted vertically with Vin = 48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).

Data Sheet

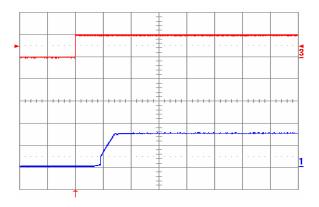


Fig. 1.5V.7: Turn-on transient at full rated load current (resistive) with no output capacitor at Vin = 48V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5V/div.). Bottom trace: output voltage (1V/div.). Time scale: 2ms/div.

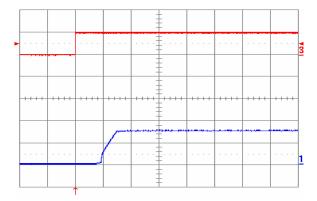


Fig. 1.5V.8: Turn-on transient at full rated load current (resistive) plus 10,000 μ F at Vin = 48V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5V/div.). Bottom trace: output voltage (1V/div.). Time scale: 2ms/div.

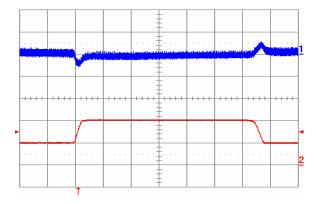


Fig. 1.5V.9: Output voltage response to load current step-change (10A - 20A - 10A) at Vin = 48V. Top trace: output voltage (100mV/div.). Bottom trace: load current (10A/div.). Current slew rate: $0.1A/\mu s$. Co = $1\mu F$ ceramic. Time scale: 0.2ms/div.

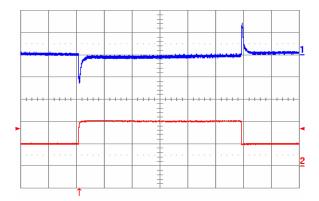


Fig. 1.5V.10: Output voltage response to load current stepchange (10A - 20A - 10A) at Vin = 48V. Top trace: output voltage (100mV/div.). Bottom trace: load current (10A/div.). Current slew rate: $5A/\mu s$. Co = $470\mu F$ POS + $1\mu F$ ceramic. Time scale: 0.2ms/div.

Data Sheet

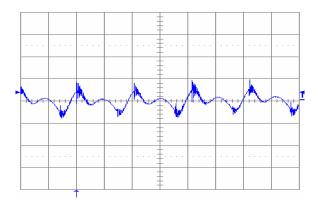


Fig. 1.5V.11: Output voltage ripple (20mV/div.) at full rated load current into a resistive load with Co = $10\mu\text{F}$ tantalum + $1\mu\text{F}$ ceramic and Vin = 48V. Time scale: $1\mu\text{S/div.}$

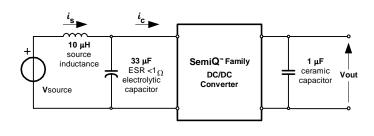


Fig. 1.5V.12: Test Set-up for measuring input reflected ripple currents, i_c and i_s .

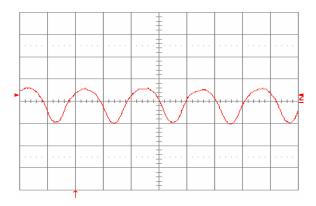


Fig. 1.5V.13: Input reflected ripple current, \emph{i}_{C} (50mA/div.), measured at input terminals at full rated load current and Vin = 48V. Refer to Fig. 1.5V.12 for test setup. Time scale: $1\mu s/\text{div}$.

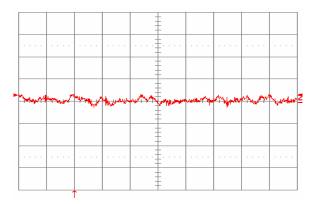


Fig. 1.5V.14: Input reflected ripple current, i_s (10mA/div.), measured through 10 μ H at the source at full rated load current and Vin = 48V. Refer to Fig 1.5V.12 for test setup. Time scale: 1 μ S/div.

Data Sheet

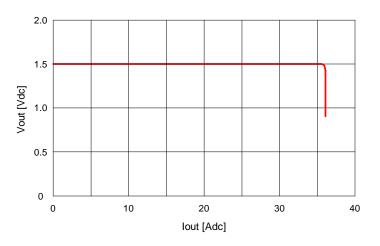


Fig. 1.5V.15: Output voltage vs. load current showing current limit point and converter shutdown point. Input voltage has almost no effect on current limit characteristic.

Fig. 1.5V.16: Load current (top trace, 20A/div., 20ms/div.) into a 10 m Ω short circuit during restart, at Vin = 48V. Bottom trace (20A/div., 1ms/div.) is an expansion of the on-time portion of the top trace.

Data Sheet

Electrical Specifications: SQE48T30012 (1.2 Volt Out)

Conditions: T_A=25°C, Airflow=300 LFM (1.5 m/s), Vin=48 Vdc, Vout=1.2 Vdc unless otherwise specified.

| PARAMETER | NOTES | MIN | TYP | MAX | UNITS |
|---|---|-------|-------|--------|---------------------|
| INPUT CHARACTERISTICS | | | | | |
| Maximum Input Current | 30 Adc, 1.2 Vdc Out @ 36 Vdc In | | | 1.2 | Adc |
| Input Stand-by Current | Vin = 48V, converter disabled | | 3 | | mAdc |
| Input No Load Current (0 load on the output) | Vin = 48V, converter enabled | · | 23 | · | mAdc |
| Input Reflected-Ripple Current | 25MHz bandwidth | | 6 | | mA _{PK-PK} |
| Input Voltage Ripple Rejection | 120Hz | | 65 | | dB |
| OUTPUT CHARACTERISTICS | | | | | |
| Output Voltage Set Point (no load) | -40°C to 85°C | 1.188 | 1.200 | 1.212 | Vdc |
| Output Regulation | | | | | |
| Over Line | | | ±1 | ±3 | mV |
| Over Load | | | ±1 | ±3 | mV |
| Output Voltage Range | Over line, load and temperature | 1.182 | | 1.218 | Vdc |
| Output Ripple and Noise - 25MHz bandwidth | Full load + 10 µF tantalum + 1 µF ceramic | | 20 | 30 | mV_{PK-PK} |
| External Load Capacitance | Plus full load (resistive) | | | 30,000 | μF |
| Output Current Range | | 0 | | 30 | Adc |
| Current Limit Inception | Non-latching | 33 | 36.5 | 40 | Adc |
| Peak Short-Circuit Current | Non-latching. Short= $10m\Omega$. | | 35 | 46 | Α |
| RMS Short-Circuit Current | Non-latching | | | 8 | Arms |
| DYNAMIC RESPONSE | | | | | |
| Load Change 10A - 20A - 10A, di/dt = 0.1 A/µS | Co = 1 µF ceramic (Fig. 1.2V.9) | | 40 | | mV |
| $di/dt = 5 A/\mu S$ | Co = 470 μ F POS + 1 μ F ceramic (Fig. 1.2V.10) | | 130 | | mV |
| Setting Time to 1% | | | 50 | | μs |
| EFFICIENCY | | | | | |
| 100% Load | | | 84 | | % |
| 50% Load | | | 86.5 | | % |

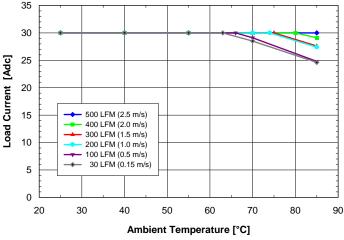


Fig. 1.2V.1: Available load current vs. ambient air temperature and airflow rates for SQE48T30012 converter with D height pins mounted vertically with air flowing from pin 3 to pin 1, MOSFET temperature \leq 120°C, Vin = 48V.

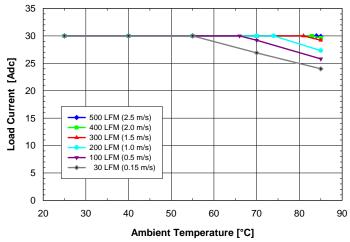


Fig. 1.2V.2: Available load current vs. ambient air temperature and airflow rates for **SQE48T30012** converter with D height pins mounted horizontally with air flowing from pin 3 to pin 1, MOSFET temperature \leq 120°C, Vin = 48V.

Data Sheet

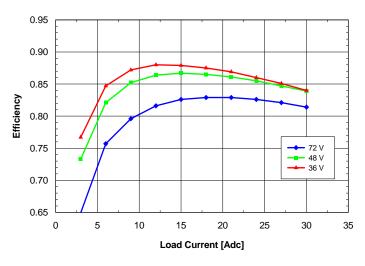


Fig. 1.2V.3: Efficiency vs. load current and input voltage for **SQE48T30012** converter mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5m/s) and $Ta = 25^{\circ}C$.

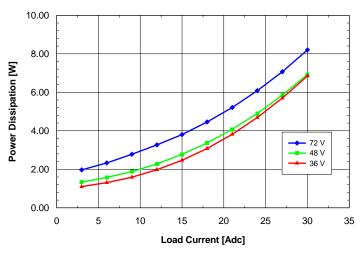


Fig. 1.2V.5: Power dissipation vs. load current and input voltage for **SQE48T30012** converter mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5m/s) and Ta = 25° C.

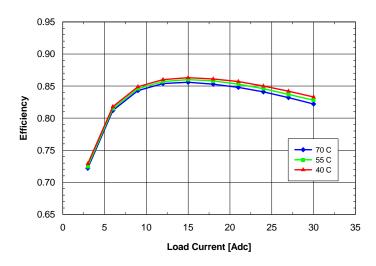


Fig. 1.2V.4: Efficiency vs. load current and ambient temperature for **SQE48T30012** converter mounted vertically with Vin = 48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).

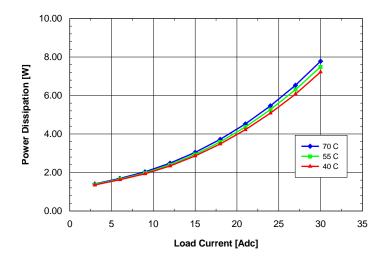


Fig. 1.2V.6: Power dissipation vs. load current and ambient temperature for **SQE48T30012** converter mounted vertically with Vin = 48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).

Data Sheet

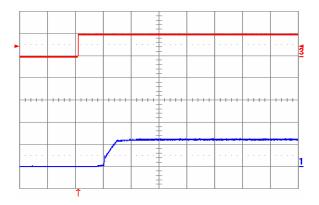


Fig. 1.2V.7: Turn-on transient at full rated load current (resistive) with no output capacitor at Vin = 48V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5V/div.). Bottom trace: output voltage (1V/div.). Time scale: 2ms/div.

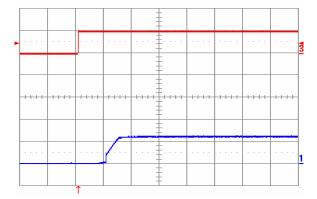


Fig. 1.2V.8: Turn-on transient at full rated load current (resistive) plus 10,000 μ F at Vin = 48V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5V/div.). Bottom trace: output voltage (1V/div.). Time scale: 2ms/div.

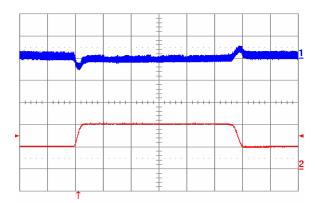


Fig. 1.2V.9: Output voltage response to load current stepchange (10A - 20A - 10A) at Vin = 48V. Top trace: output voltage (100mV/div.). Bottom trace: load current (10A/div.). Current slew rate: $0.1A/\mu s$. Co = $1\mu F$ ceramic. Time scale: 0.2ms/div.

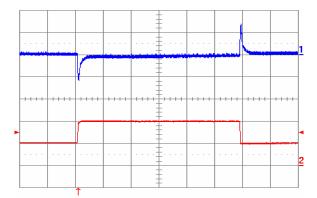


Fig. 1.2V.10: Output voltage response to load current stepchange (10A - 20A - 10A) at Vin = 48V. Top trace: output voltage (100mV/div.). Bottom trace: load current (10A/div.). Current slew rate: $5A/\mu s$. Co = $470\mu F$ POS + $1\mu F$ ceramic. Time scale: 0.2ms/div.

Data Sheet

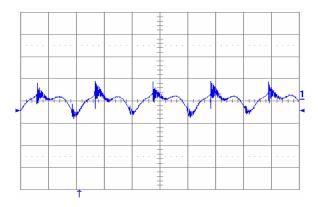


Fig. 1.2V.11: Output voltage ripple (20mV/div.) at full rated load current into a resistive load with Co = $10\mu\text{F}$ tantalum + $1\mu\text{F}$ ceramic and Vin = 48V. Time scale: $1\mu\text{S/div.}$

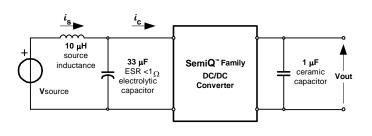


Fig. 1.2V.12: Test Set-up for measuring input reflected ripple currents, i_c and i_s .

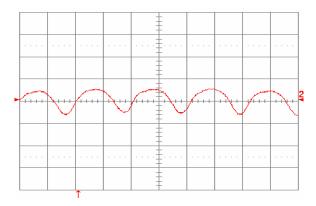


Fig. 1.2V.13: Input reflected ripple current, $\it i_{\rm c}$ (50 mA/div.), measured at input terminals at full rated load current and Vin = 48V. Refer to Fig. 1.2V.12 for test setup. Time scale: $1\mu s/div$.

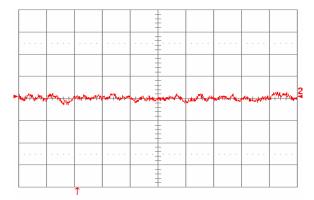


Fig. 1.2V.14: Input reflected ripple current, i_s (10mA/div.), measured through 10 μ H at the source at full rated load current and Vin = 48V. Refer to Fig. 1.2V.12 for test setup. Time scale: 1 μ s/div.

Data Sheet

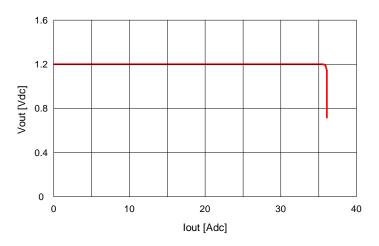
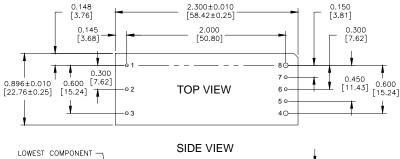


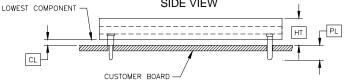
Fig. 1.2V.15: Output voltage vs. load current showing current limit point and converter shutdown point. Input voltage has almost no effect on current limit characteristic.

Fig. 1.2V.16: Load current (top trace, 20A/div., 20ms/div.) into a 10 m Ω short circuit during restart, at Vin = 48V. Bottom trace (20A/div., 1ms/div.) is an expansion of the on-time portion of the top trace.

Data Sheet

Physical Information





SQE48T Pinout (Through-hole)

| Height | HT (Max. Height) | CL (Min. Clearance) |
|--------|---------------------|------------------------|
| Option | +0.000 [+0.00] | +0.016 [+0.41] |
| | -0.038 [- 0.97] | -0.000 [- 0.00] |
| D | 0.381 [9.68] | 0.008 [0.3] |

| Pin | PL Pin Length |
|--------|------------------|
| Option | ±0.005 [±0.13] |
| Α | 0.188 [4.77] |
| В | 0.145 [3.68] |
| С | 0.110 [2.79] |

| Pad/Pin Connections | | | | | | |
|---------------------|-------------------|--|--|--|--|--|
| Pad/Pin # | Function | | | | | |
| 1 | Vin (+) | | | | | |
| 2 | ON/OFF Vin (-) | | | | | |
| 3 | | | | | | |
| 4 | Vout (-) | | | | | |
| 5 | SENSE(-) | | | | | |
| 6 | TRIM | | | | | |
| 7 | SENSE(+) | | | | | |
| 8 | Vout (+) | | | | | |

SQE48T Platform Notes

- All dimensions are in inches [mm]
- Pins 1-3 and 5-7 are Ø 0.040" [1.02] with Ø 0.078" [1.98] shoulder
- Pins 4 and 8 are Ø 0.062" [1.57] without shoulder
- Pin material: Brass
- Pin Finish: Tin/Lead over Nickel
- Converter Weight: 0.72 oz [20.6 g]

Converter Part Numbering Scheme

| Product Series | Input Voltage | Mounting Scheme | Rated Load Current | Output Voltage | | ON/OFF Logic | Maximum Height [HT] | Pin Length [PL] | Special Features |
|-------------------------------|------------------|--------------------|-----------------------|--|---|---|-------------------------|---|---------------------|
| SQE | 48 | Т | 30 | 033 | - | N | D | В | 0 |
| One-Eighth Brick Format | 36-75 V | T⇒ Through-hole | 30A (1.2 – 3.3V) | $012 \Rightarrow 1.2V$ $015 \Rightarrow 1.5V$ $018 \Rightarrow 1.8V$ $025 \Rightarrow 2.5V$ $033 \Rightarrow 3.3V$ | | $N \Rightarrow$ Negative $P \Rightarrow$ Positive | Through hole D ⇒ 0.381" | Through hole A ⇒ 0.188" B ⇒ 0.145" C ⇒ 0.110" | $0 \Rightarrow STD$ |

The example above describes P/N SQE48T30033-NDB0: 36-75V input, through-hole mounting, 30A @ 3.3V output, negative ON/OFF logic, a maximum height of 0.381", and a through the board pin length of 0.145". Please consult factory regarding availability of a specific version.

For more information please contact di/dt, a Power-One company

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